

SUPERMICE

SuperServer 2029TP-HTR

Tested SIOM Network Card (AOC) Matrix





Views: | Angled View | Node View | Front View Rear View

Barebone or Complete System requires SIOM or network card installed per node.

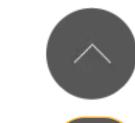
<u>Drivers & Utilities</u> <u>BIOS</u> <u>IPMI</u> <u>Tested Memory</u> <u>Tested M.2 List</u> <u>Manuals</u> <u>OS Certification Matrix</u> <u>Quick-References Guide</u> <u>Drive Options</u>

Key Features

- Compute Intensive Application

- Mission-critical applications

- HPC, Data Center
- Enterprise Server - Financial Analysis
- Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:
- 1. Dual Socket P (LGA 3647) support 2nd Gen Intel® Xeon® Scalable processors (Cascade Lake/Skylake)[‡]
- 2. 16 DIMMs; up to 4TB 3DS ECC DDR4-2933MHz[†] RDIMM/LRDIMM, Supports Intel® Optane™ DCPMM^{††}
- 3. 2 PCI-E 3.0 x16 (LP) slots 4. Flexible Networking support via SIOM;
- Dedicated IPMI 2.0 LAN 5. 6 Hot-swap 2.5" SATA3 drive bays
- 6. Up to 2200W Redundant Power Supplies Titanium Level (96%)



Print

Note: Image above may show a varied configuration of optional parts. Please refer to parts list for standard parts included.

Product SKUs
SYS-2029TP-HTR SuperServer 2029TP-HTR (Black)
Motherboard (Four per System)
Super X11DPT-PS
Processor (per Node)
CPU Dual Socket P (LGA 3647) 2nd Gen Intel® Xeon® Scalable Processors and Intel® Xeon® Scalable Processors‡, Dual UPI up to 10.4GT/s Support CPU TDP 70-165W*
Cores Up to 28 Cores
Note * Please contact Supermicro Technical Support for supporti conditions of high power (TDP 150W and above) or high bas frequency (3.0 GHz and above) processors.
Note *Processors ending N or S are optimized for networking and storage applications. Customer need POC their application observe any thermal throttling before large deployment.
Note [‡] BIOS version 3.2 or above is required to support 2nd Gen Intel® Xeon® Scalable processors (codenamed Cascade Lake
System Memory (per Node)
Memory Capacity 16 DIMM slots Up to 4TB 3DS ECC DDR4-2933MHz [†] RDIMM/LRDIMM Supports Intel® Optane™ DCPMM ^{††}
Memory Type 2933 [†] /2666/2400/2133MHz ECC DDR4 RDIMM/LRDIMM
Note † 2933MHz in two DIMMs per channel can be achieved by us memory purchased from Supermicro †† Cascade Lake only. Contact your Supermicro sales rep formore info.
On-Board Devices (per Node)

Chipset	Intel® C621 chipset

SATA3 (6Gbps); RAID 0, 1, 5, 10 support **SATA** Barebones and Complete System must have at least one **Network Controllers**

SIOM or network card installed per node

Support for Intelligent Platform Management Interface v.2.0 **IPMI** IPMI 2.0 with virtual media over LAN and KVM-over-LAN support

Input / Output (per Node)

SATA

Graphics

Software

1 RJ45 Dedicated IPMI LAN port LAN 2 USB 3.0 ports (rear) **USB** 1 VGA port 1 Fast UART 16550 port / 1 Header (internal) **Serial Port / Header** 2 <u>SuperDOM</u> support on the motherboard Others

ASPEED AST2500 BMC

6 SATA3 (6Gbps) ports

1 NVMe or 2 SATA M.2 (22x80/60/42 mm) support with option part: AOC-SMG3-2H8M2 M.2 and SuperDOM are for OS boot and they cannot coexist

System BIOS AMI 32MB SPI Flash ROM **BIOS Type**

Management

IPMI 2.0 KVM with dedicated LAN NMI SSM, SPM, SUM

SuperDoctor® 5 Watchdog **ACPI Power Management**

Intel[®] Node Manager

CPU

Parts List - (Items Included)

PC Health Monitoring

Power Configurations

5+1 Phase-switching voltage regulator Fans with tachometer monitoring **FAN** Status monitor for speed control

Monitors for CPU Cores, Chipset Voltages, Memory.

Pulse Width Modulated (PWM) fan connectors Monitoring for CPU and chassis environment **Temperature** Thermal Control for fan connectors **Omni-Path Fabric CPUs** Do not support

Chassis	

Form Factor 2U Rackmount **CSE-217HQ+-R2K20BP3** Model

Dimensions and Weight

17.25" (438mm) Width 3.47" (88mm) Height 28.5" (724mm) Depth

Power On/Off button

Gross Weight: 90 lbs (40.9kg)

Net Weight: 72 lbs (32.7 kg) **Available Colors** Black

Front Panel

Buttons

Weight

UID button **LEDs** Power status LED **HDD** activity LED Network activity LEDs Universal Information (UID) LED

Expansion Slots (per Node)

PCI-Express

Note: Barebones and Complete System must bundle with

1 SIOM card support

Network Card (With only one CPU installed, SXB2 M.2 and SXB4 riser card

slots not function)

2 PCI-E 3.0 x16 Low-profile slots

Hot-swap

AC Input Frequency

System Cooling

Drive Bays (per Node)

4 Heavy duty 8cm PWM fans with optimal fan speed control **Fans**

6 Hot-swap 2.5" SATA3 drive bays

2200W Redundant Power Supplies with PMBus

Power Supply

1200W with Input 100-127Vac **Total Output Power and** 1800W with Input 200-220Vac Input

1980W with Input 220-230Vac 2090W with Input 230-240Vac

2200W with Input 220-240Vac (for UL/cUL use only) 2090W with Input 230-240Vdc (for CCC only)

50-60Hz

76 x 40 x 336 mm **Dimension** $(W \times H \times L)$ Max: 100A / Min: 0A (100-127Vac) +12V

Max: 150A / Min: 0A (200-220Vac) Max: 165A / Min: 0A (220-230Vac) Max: 174.17A / Min: 0A (230-240Vac) Max: 183.3A / Min: 0A (220-240Vac)

Max: 1A / Min: 0A **5VSB Output Type** Backplanes (gold finger) Certification **Titanium Level** [Test Report]

RoHS

Operating Environment

Environmental Spec.

Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F) Non-operating Temperature: -40°C to 60°C (-40°F to 140°F) Operating Relative Humidity: 8% to 90% (non-condensing)

RoHS Compliant

Non-operating Relative Humidity: 5% to 95% (non-condensing)

Parts List ^

	Part Number	Qty	Description
Motherboard / Chassis	MBD-X11DPT-PS	4	Super X11DPT-PS Motherboards
	CSE-217HQ+-R2K20BP3	1	2U Chassis
Backplane	BPN-ADP-6SATA3P	4	Backplan adapter card; 6SATA ports,RoHS/REACH,PBF
Backplane	BPN-SAS3-217HQ2	1	2U 24-Port 4-Node Backplane Supports 6x2.5
Cable 1	CBL-PWCD-0578	2	PWCD,US,IEC60320 C14 TO C13,3FT,14AWG
Air Shroud	MCP-310-21716-0B	4	Twinpro X11 air shroud
Riser Card	RSC-P-6	4	RSC-P-6 (1U LHS TwinPro RSC with 1 PCI-Ex16),RoHS
Riser Card	RSC-R1UTP-E16R	4	1U RHS TwinPro Riser card with one PCI-E x16 slot
Heatsink / Retention	SNK-P0067PS	4	1U Passive CPU Heat Sink for X11 Purley Platform Equipped with a Narrow Retention Mechanism
Heatsink / Retention	SNK-P0067PSM	4	1U Passive CPU Heat Sink with a 26-mm Wide Middle Air Channel for X11 Purley Platform Equipped with a Narrow Retention Mechanism
Power Supply	PWS-2K20A-1R	2	1U 2200W Redundant, Titanium, 76(W) X 40(H) X 336(L) mm
Oution al Doute List			
Optional Parts List			

	Part Number	Qty	Description
TPM security module (optional, not included)	AOM-TPM-9670V	1	SPI capable TPM 2.0 with Infineon 9670 controller with vertical form factor
TPM security module (optional, not included)	AOM-TPM-9671V	1	SPI capable TPM 1.2 with Infineon 9670 controller with vertical form factor
Add-on-Card	AOC-SMG3-2H8M2	-	AOC supports 2280 M.2 form factor SSD (1 NVMe or 2 SATA), FST-SCRW-0121L is included in AOC-SMG3-2H8M2
Global Services & Support	OS4HR3/2/1 OSNBD3/2/1	-	3/2/1-year onsite 24x7x4 service 3/2/1-year onsite NBD service
Software	SFT-OOB-LIC • @Store	1	OOB Management Package (per node license)
Software	SFT-DCMS-Single	1	DataCenter Management Package (per node license)



Global SKU



English





About Us

Investor Relations Careers Site Map

Press Releases Supermicro in the News **Product Reviews Events** Webinars

News

Product Briefs

Resources

Solution Briefs Success Stories Videos White Papers MySupermicro



Contact Us Newsletter Sign-up





